Ionic liquid epoxy resin monomers capable of reacting with cross-linking agents to form polymers with high tensile and adhesive strengths. Ionic liquid epoxy monomers comprising at least one bis(glycidyl) N-substituted nitrogen heterocyclic cation are made from nitrogen heterocycles corresponding to the bis(glycidyl) N-substituted nitrogen heterocyclic cations by a method involving a non-nucleophilic anion, an alkali metal cation, epichlorohydrin, and a strong base.
FIG. 1

(I)  

(II)  

(III)
FIG. 2

(IV)
FIG. 4

(VIII)

(IX)

(X)
FIG. 5

(XI)

(XII)

(XIII)
Ionic Liquid Epoxy Resin Monomers

Cross-Reference to Related Applications

This Application is a Division of and claims priority under 35 U.S.C. 121 to U.S. Ser. No. 12/168,085, filed Jul. 7, 2008, which is incorporated by reference in its entirety.

Statement Regarding Federally Sponsored Research

The U.S. Government may have certain rights to this invention pursuant to NASA MSFC IRAD Project #6-04.

Background of the Invention

The present invention relates to ionic liquid epoxy compositions and their synthesis, and to ionic liquid epoxy monomers that form polymeric resins having desirable properties as adhesives, coatings, and composites.

Fabrication and repair operations inside spacecraft and other confined spaces require composites and adhesives that produce minimal or no harmful off-gassing products. Spacecraft additionally require structural components that must be prepared in and/or withstand harsh environments such as extreme temperatures, and hard vacuum.

Current epoxies, while significantly improved over earlier materials, tend to have off-gassing and flammability issues, especially in confined environments. Many cannot be handled in a space environment because hard vacuum and cryogenic temperatures cause them to rapidly evaporate and/or freeze. Even epoxy resins that are mixed and/or cured at ambient temperature and pressure often do not perform well at cryogenic temperatures because they become brittle. Current aerospace epoxies have a lower service temperature limit of -45°F as neat (unfilled) resins.

Adhesives and coatings comprising ionic liquids (ILs) that avoid the use of volatile organic compounds (VOC) as a solvent are known (US 2007/0194275 A1; US 2008/0017224 A1). Adhesives and coatings of this type having high tensile and adhesive strengths at ambient temperatures as well as cryogenic temperatures, however, are not known. The present invention overcomes these limitations by providing IL epoxy monomers that react with cross-linking agents to form polymers exhibiting high tensile and adhesive strengths at extremely low temperatures. These properties make the polymers particularly well-suited for use in adhesives, coatings, composites, or articles of manufacture for use in harsh environments such as low temperatures and high physical stresses.

Brief Summary of the Invention

The present invention comprises a series of ionic liquid epoxy monomers and methods for their making.

Brief Description of the Drawings

FIG. 1 shows the chemical structures of three embodiments (I-III) of ionic liquid epoxy monomer resins according to the present invention.

FIG. 2 shows the chemical structure of a fourth embodiment (IV) a monomer resin according to the present invention.

FIG. 3 shows the chemical structures of three preferred diamine curing agents (V-VII).

FIG. 4 shows the chemical structures of exemplary IL epoxy monomer resin (VIII), cross-linked polymeric epoxy resin (IX), and linear polymeric epoxy resin (X).

FIG. 5 shows the chemical structures of exemplary IL epoxy monomer resin (XI), cross-linked polymeric epoxy resin (XII), and linear polymeric epoxy resin (XIII).

Detailed Description of the Invention

Curing of Monomer Resin (VIII) to form Polymer Resin (IX)

An exemplary IL epoxy monomer resin (VIII) (FIG. 4) was synthesized using the following protocol: 30 g of lithium trifluoromethanesulfonimide is added to 80 mL of epichlorohydrin in a 125 mL stoppered flask surrounded by a water bath, and the mixture is stirred for several minutes until the solid dissolves completely. 6.8 g of imidazole and 4 g sodium hydroxide pellets are added and the mixture is stirred overnight, using the water bath to maintain the temperature at 20-25°C. The solid material is filtered off, and carbon dioxide gas is bubbled through the solution for 15-30 min. to neutralize residual sodium hydroxide. Excess epichlorohydrin is removed by distillation under reduced pressure, leaving a viscous liquid resin, which is then washed with 50 mL distilled water. The crude product layer is allowed to settle, yielding approximately 30 g of 1,3-bis(glycidyl)imidazolium trifluoromethanesulfonimide, which is the IL epoxy monomer resin. The amounts of materials, temperatures, and times described are for illustrative purposes and may be modified within the scope of the present invention.

Example 1

Synthesis of Monomer Resin (VIII)

Example 2

Curing of Monomer Resin (VIII) to form Polymer Resin (IX)

To cure the ionic liquid monomer resin (VIII) into a polymeric epoxy resin, the following protocol was used: 2.5 g of...
the monomer and curing agent, and/or mixture of the two prior to hardening. In some cases it may be desirable to form IL epoxide polymers using a ratio of IL epoxide monomer to curing agent that is less than 2:1. For example, compounds (V) and (VIII) may be mixed in a 1:1 molar ratio to form the polymer compound (X), or compounds (V) and (X) may be mixed in a 1:1 molar ratio to form the polymer compound (XIII).

Heating a mixture of monomer and curing agent may be accomplished by applying a current to the mixture. The temperature and degree of curing may be varied by controlling the current applied. As the polymer forms, the conductivity of the mixture decreases, allowing the degree of polymerization to be estimated electronically during the curing process.

Preparation of an II. Epoxide Polymer Composite

Example 3

A 2-ply graphite fabric composite was prepared using a hand layup method from monomer (VIII) and curing agent (V). Testing of the resulting composite yielded an average stress at maximum load of 59,730 psi and average Modulus of 7.7x10^6 psi at room temperature. At a temperature of —150° F, the average stress at maximum load was 78,230 psi and the Modulus was 9.5x10^6 psi at —150° F. It will be understood by those skilled in the art that II. epoxide polymer composites according to the present invention may be made using materials other than graphite fabric that are commonly used in the fabrication of composite materials.

Preferred embodiments of the invention are shown and described herein. It will be clear to those skilled in the art that various changes and modifications can be made without departing from the invention as described in the following claims.

The invention claimed is:

1. An ionic liquid epoxide monomer having the general structure:
wherein: \(X\) is hydrogen, an alkyl group, a substituted alkyl group, a halogen, an aromatic ring, or a substituted aromatic ring attached through a carbon atom; \(Y\) is an alkyl group, a substituted alkyl group, an aromatic ring, or a substituted aromatic ring; \(A^-\) is selected from the group consisting of \((\text{CF}_3\text{SO}_2)_2\text{N}^-\), \(\text{CF}_3\text{SO}_3^-\), vinylsulfonate, and styrenesulfonate, and \(n\) is a positive integer.

2. The ionic liquid epoxide monomer of claim 1, having the chemical structure

3. The ionic liquid epoxide monomer of claim 2 wherein the anion is \((\text{CF}_3\text{SO}_2)_2\text{N}^-\), or \(\text{CF}_3\text{SO}_3^-\).

4. A method for making an ionic liquid epoxide monomer according to claim 1, comprising at least one bis(glycidyl) \(N\)-substituted nitrogen heterocyclic cation, said method comprising:
   i) dissolving a non-nucleophilic anion and an alkali metal cation in an excess epichlorohydrin to form a solution,
   ii) dissolving a strong base in the solution,
   iii) dissolving a nitrogen heterocycle corresponding to the bis(glycidyl) \(N\)-substituted nitrogen heterocyclic cation in the solution containing the strong base,
   iv) stirring the solution at a temperature of 20-25°C for at least 2 hours, to form a precipitate,
   v) removing the precipitate from the solution,
   vi) neutralizing residual strong base,
   vii) removing excess epichlorohydrin to leave a viscous ionic liquid epoxide monomer resin
   viii) removing chloride ion by washing the ionic liquid epoxide monomer resin with water, and
   ix) removing residual water from the ionic liquid epoxide monomer resin.

5. The method of claim 4, wherein the non-nucleophilic anion is trifluoromethanesulfonimide and the alkali metal cation is lithium cation.

6. The method of claim 4, wherein the ionic liquid epoxide monomer resin has the chemical structure

7. The method of claim 4, wherein the ionic liquid epoxide monomer resin is washed with water until the wash water tests negative for chloride ion with silver nitrate solution.

8. The method of claim 4, wherein the strong base is neutralized by bubbling carbon dioxide through the solution.

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